

CD40257B Types

CMOS Quad 2-Line-to-1-Line Data Selector/Multiplexer

High-Voltage Types (20-Volt Rating)

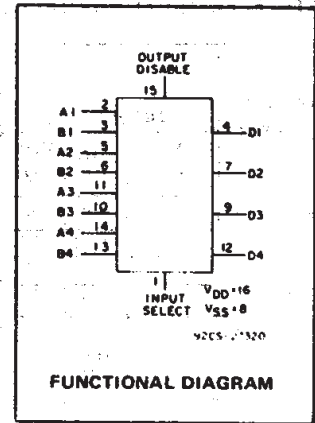
■ CD40257B is a Data Selector/Multiplexer featuring three-state outputs which can interface directly with and drive data lines of bus-oriented systems. The CD40257B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V _{DD})	
Voltages referenced to V _{SS} Terminal	-0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	-0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (P _D):	
For T _A = -55°C to +100°C	500mW
For T _A = +100°C to +125°C	Derate Linearly at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR T _A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	100mW
OPERATING-TEMPERATURE RANGE (T _A)	-55°C to +125°C
STORAGE TEMPERATURE RANGE (T _{stg})	-65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max	+265°C

Features:

- 3-state outputs
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range):
 - 1 V at V_{DD} = 5 V
 - 2 V at V_{DD} = 10 V
 - 2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"



Applications:

- Digital Multiplexing
- Shift-right/shift-left registers
- True/complement selection

RECOMMENDED OPERATING CONDITION

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	Min.	Max.	
Supply-Voltage Range (For T _A =Full Package-Temperature Range)	3	18	V

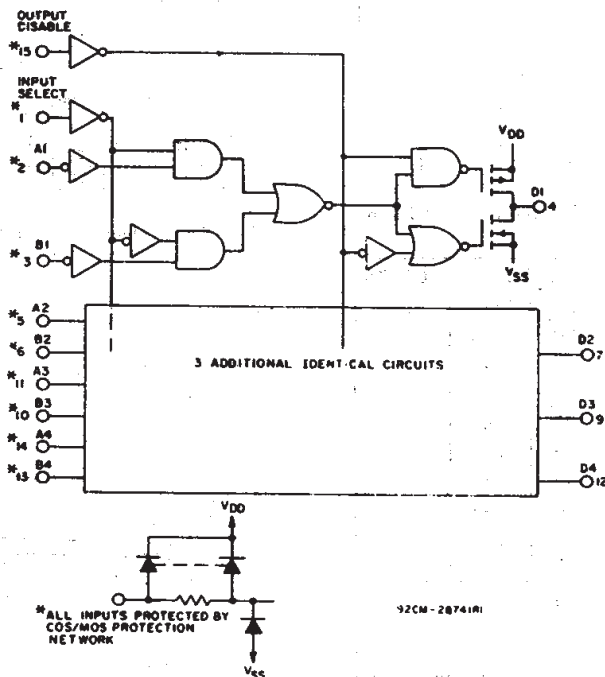


Fig. 1 - Logic diagram for CD40257B.

TRUTH TABLE

3-STATE OUTPUT DISABLE	INPUTS		OUTPUT
	SELECT	A B	
1	X	X X	Z
0	0	0 X	0
0	0	1 X	1
0	1	X 0	0
0	1	X 1	1

X = DON'T CARE LOGIC 1 = HIGH
LOGIC 0 = LOW Z = HIGH IMPEDANCE

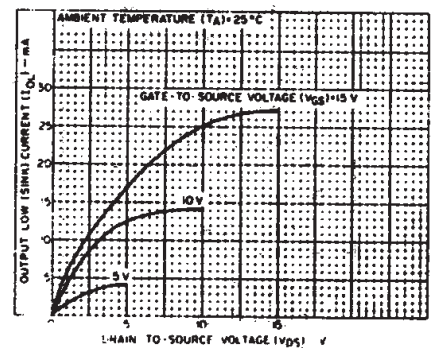


Fig. 2 - Typical output low (sink) current characteristics.

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STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent Device Current	-	0.5	5	1	1	30	30	-	0.02	1	μA
I _{DD} Max.	-	0.10	10	2	2	60	60	-	0.02	2	
	-	0.15	15	4	4	120	120	-	0.02	4	
Output Low (Sink) Current, I _{OL} Min.	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	-	mA
	0.5	0.10	10	1.6	1.5	1.1	0.9	1.3	2.6	-	
	1.5	0.15	15	4.2	4	2.8	2.4	3.4	6.8	-	
Output High (Source) Current, I _{OH} Min.	4.6	0.5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
	2.5	0.5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	-	
	9.5	0.10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	-	
Output Voltage: Low-Level, V _{OL} Max.	-	0.5	5			0.05			0	0.05	V
	-	0.10	10			0.05			0	0.05	
	-	0.15	15			0.05			0	0.05	
Output Voltage: High-Level, V _{OH} Min.	-	0.5	5			4.95		4.95	5	-	V
	-	0.10	10			9.95		9.95	10	-	
	-	0.15	15			14.95		14.95	15	-	
Input Low Voltage, V _{IL} Max.	0.5, 4.5	-	5			1.5		-	-	1.5	V
	1.9	-	10			3		-	-	3	
	1.5, 13.5	-	15			4		-	-	4	
Input High Voltage, V _{IH} Min.	0.5, 4.5	-	5			3.5		3.5	-	-	V
	1.9	-	10			7		7	-	-	
	1.5, 13.5	-	15			11		11	-	-	
Input Current, I _{IN} Max.	-	0.18	18	±0.1	±0.1	±1	±1	-	±10 ⁻⁵	±0.1	μA
3-State Output Leakage Current I _{OUT} Max.		0.18	18	±0.4	±0.4	±12	±12	-	±10 ⁻⁴	±0.4	μA

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C; Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 KΩ

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS	
		V _{DD} (V)	Typ.		Max.
Propagation Delay Time: Data Input to Output, t _{PHL} , t _{PLH}		5	150	300	ns
		10	70	140	
		15	50	100	
Select to Output, t _{PHL} , t _{PLH}		5	190	380	ns
		10	85	170	
		15	65	130	
Output Disable to Output, t _{PHL} , t _{PLH}		5	95	190	ns
		10	50	100	
		15	40	80	
Transition Time, t _{THL} , t _{TLH}		5	100	200	ns
		10	50	100	
		15	40	80	
Input Capacitance, C _{IN}	Any Input	-	5	7.5	pF

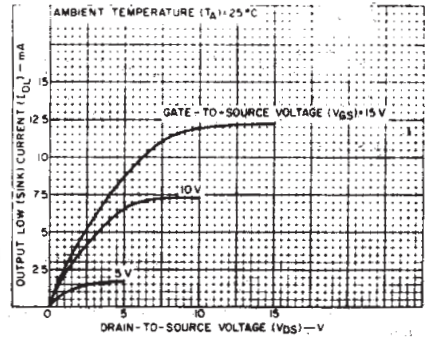


Fig.3 - Minimum output low (sink) current characteristics.

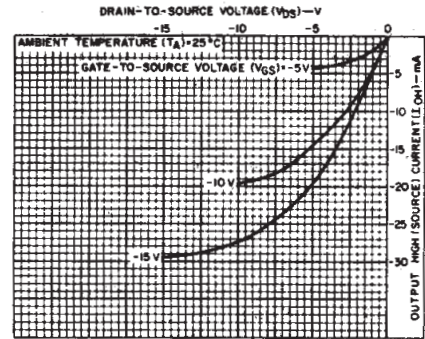


Fig.4 - Typical output high (source) current characteristics.

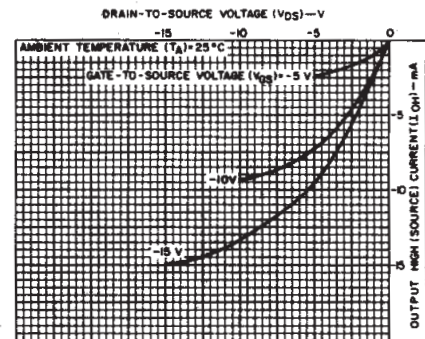


Fig.5 - Minimum output high (source) current characteristics.

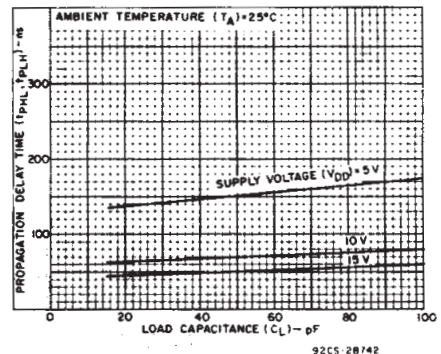


Fig.6 - Typical propagation delay time as a function of load capacitance (DATA INPUT to OUTPUT).

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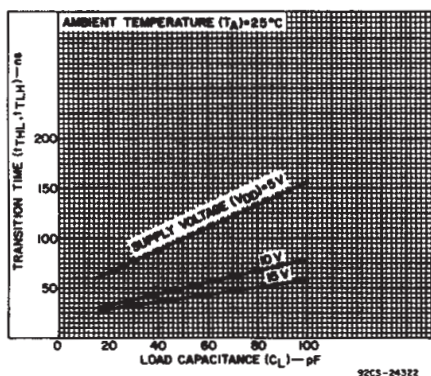


Fig.7 - Typical transition time as a function of load capacitance.

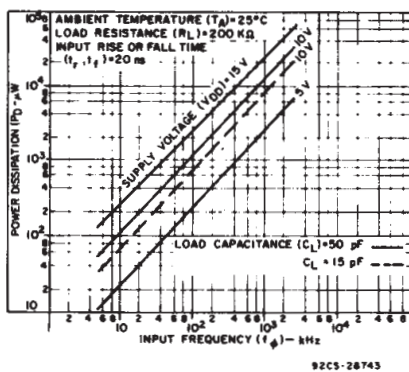


Fig.8 - Typical dynamic power dissipation as a function of input frequency (one INPUT to one OUTPUT).

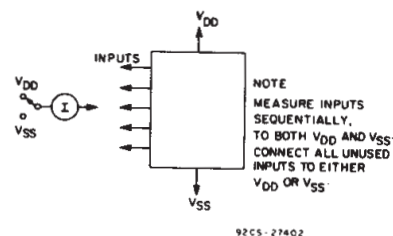


Fig.9 - Input current test circuit.

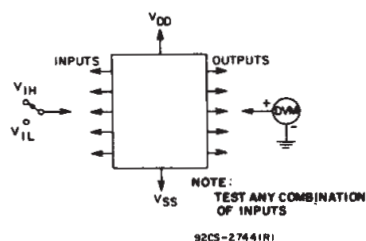


Fig.10 - Input voltage test circuit.

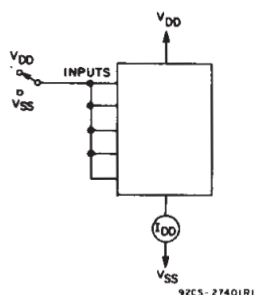
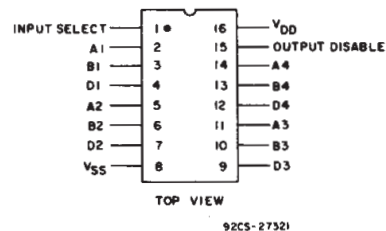
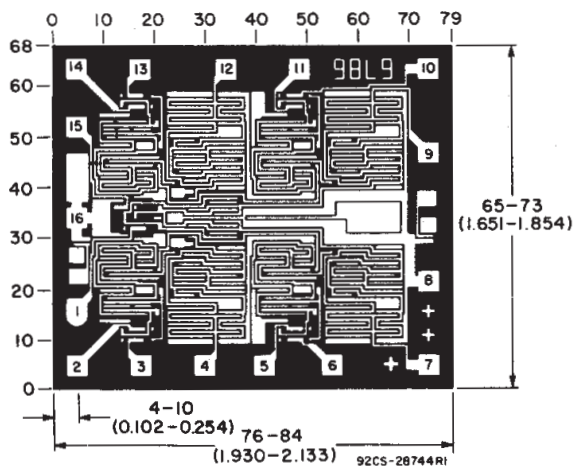


Fig.11 - Quiescent device current test circuit.



TERMINAL ASSIGNMENT

Dimensions and pad layout for CD40257BH.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10⁻³ inch).

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J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



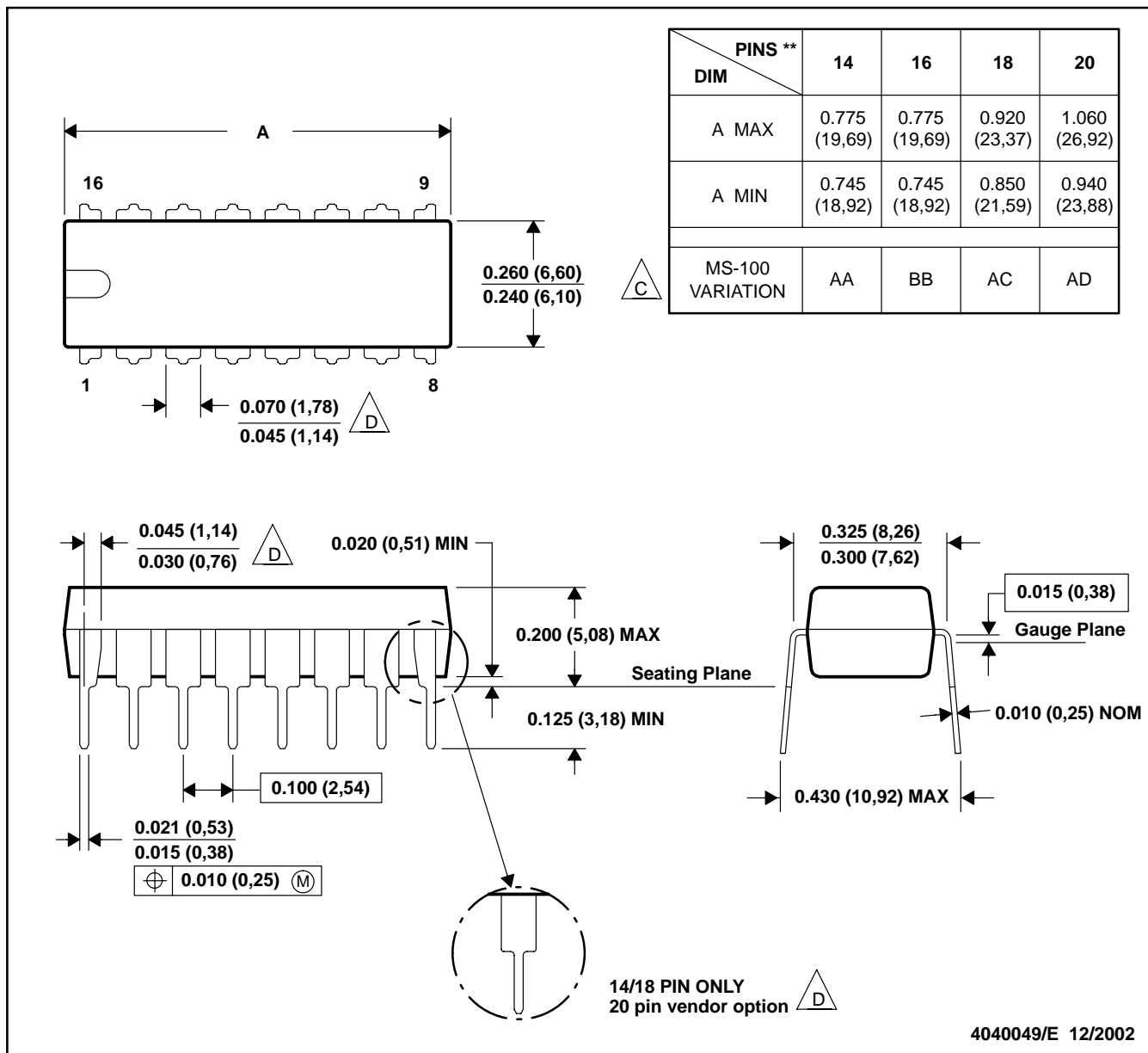
4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-012

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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